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IEEE ICMA 2018

2018 IEEE International Conference on Mechatronics and Automation

August 5-8, 2018, Changchun, China



Co-sponsors: IEEE Robotics and Automation Society, CIOMP, Kagawa Univ., BIT

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Call for Papers



The 2018 IEEE International Conference on Mechatronics and Automation (ICMA 2018) will take place in Changchun, China from August 5 to August 8, 2018. A renowned ancient city in China, Changchun is situated in northeastern China. As the capital of Jilin province, Changchun is known as the cradle of new China's automobile industry, optoelectronics technology and biological technology, applied chemistry and so on.

As the host city of ICMA 2018, Changchun not only provides the attendees with a great venue for this event, but also an unparalleled experience in Chinese history and culture. You are cordially invited to join us at IEEE ICMA 2018 in Changchun to live this unique experience. The objective of ICMA 2018 is to provide a forum for researchers, educators, engineers, and government officials involved in the general areas of mechatronics, robotics, automation and sensors to disseminate their latest research results and exchange views on the future research directions of these fields.

The topics of interest include, but not limited to the following:

- Intelligent mechatronics, robotics, biomimetics, automation, control systems,
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Organized Sessions: Proposals with the title, the organizers, and a brief statement of purpose of the session must be submitted to an OS Chair by April 10, 2018.

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Important Dates:

April 10, 2018 Full papers and organized session proposals
May 1, 2018 Proposals for tutorials and workshops
May 15, 2018 Notification of paper and session acceptance
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